PRELIMINARY

SFF9240C

SOLID STATE DEVICES, INC

14849 Firestone Boulevard · La Mirada,CA 90638
Phone: (714) 670-SSDI (7734) · Fax: (714) 522-7424

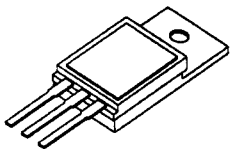
-11 AMP
-200 VOLTS
0.50Ω
P-CHANNEL
POWER MOSFET

Designer's Data Sheet

FEATURES:

- Rugged construction with poly silicon gate
- Low RDS(on) and high transconductance
- Excellent high temperature stability
- Very fast switching speed
- Fast recovery and superior dv/dt performance
- Increased reverse energy capability
- Low input and transfer capacitance for easy paralleling
- Hermetically sealed
- TX, TXV and Space Level Screening available
- Replaces: IRF9240 Types

TO-254C



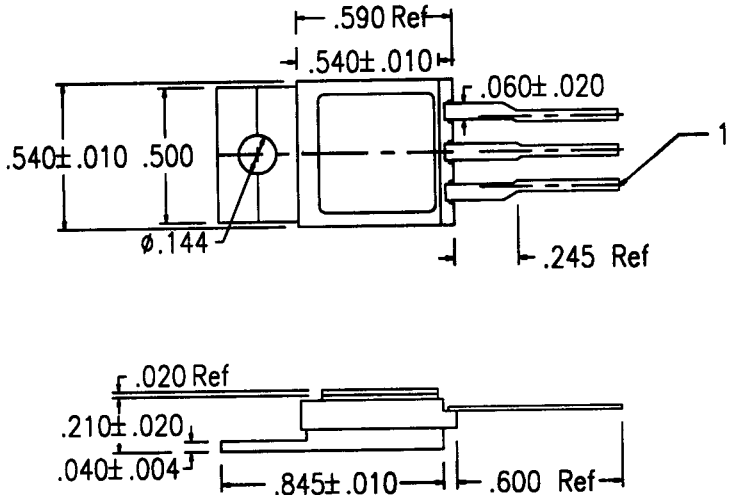
MAXIMUM RATINGS

CHARACTERISTIC	SYMBOL	VALUE	UNIT
Drain to Source Voltage	V_{DS}	-200	Volts
Gate to Source Voltage	V_{GS}	±20	Volts
Continuous Drain Current	I_D	-11	Amps
Operating and Storage Temperature	T_{op} & T_{stg}	-55 to +150	°C
Thermal Resistance, Junction to Case	$R_{\theta JC}$	1.7	°C/W
Total Device Dissipation @ TC=25°C Total Device Dissipation @ TC=55°C	P_D	74 56	Watts

PACKAGE OUTLINE: CERAMIC TO-254

PIN OUT:

PIN 1: DRAIN
PIN 2: SOURCE
PIN 3: GATE



NOTE: All specifications are subject to change without notification. SCD's for these devices should be reviewed by SSDI prior to release.

DATA SHEET #: FP0005 A

MED

SFF9240C

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ELECTRICAL CHARACTERISTICS @ TJ=25 C (Unless Otherwise Specified)

RATING		SYMBOL	MIN	TYP	MAX	UNIT
Drain to Source Breakdown Voltage (VGS=0 V, ID=-250μA)		BVDSS	-200	---	---	V
Drain to Source on State Resistance (VGS= -10 V, ID= -6 A)		RDS(on)	---	0.35	0.50	Ω
On State Drain Current (VDS >ID(on) X RDS(on) Max, VGS= -10 V		ID(on)	-11	---	---	A
Gate Threshold Voltage (VDS=VGS, ID=-250μA)		VGS(th)	-2.0	---	-4.0	V
Forward Transconductance (VDS ≥ ID(on) X RDS(on) max., IDS= -6.0 A)		gfs	4	6	---	S(℧)
Zero Gate Voltage Drain Current (VDS=max rated voltage, VGS=0 V) (VDS=80% rated VDS, VGS=0 V, TA=125°C)		IDSS	--- ---	--- ---	-250 -1000	μA
Gate to Source Leakage Forward **Gate to Source Leakage Reverse**	VGS= ±20V	IGSS	--- ---	--- ---	-100 100	nA
Total Gate Charge **Gate to Source Charge** **Gate to Drain Charge**	VGS= -15 Volts 80% rated VDS ID= -22 A	Qg Qgs Qgd	--- --- ---	38 8.0 21	90 --- ---	nC
Turn on Delay Time **Rise Time** **Turn Off Delay Time** **Fall Time**	VDD= -100 V ID= -6 A RG= 4.7Ω	td(on) tr td(off) tf	--- --- --- ---	13 45 29 29	30 15 18 12	nsec
Diode Forward Voltage (IS= -11 A, VGS=0 V, TJ=25°C)		VSD	---	---	-4.6	V
Diode Reverse Recovery Time **Reverse Recovery Charge**	TJ=150°C IF=-11 A di/dt=100 A/ sec	trr QRR	--- ---	270 2.0	--- ---	nsec μC
Input Capacitance **Output Capacitance** **Reverse Transfer Capacitance**	VGS=0 Volts VDS= -25 Volts f= 1 MHz	Ciss Coss Crss	--- --- ---	1100 375 150	1300 450 250	pF

For thermal derating curves and other characteristic curves please contact SSDI Marketing Department.